TE Internal #: 3-292206-3

PCB Mount Header, Horizontal, Wire-to-Board, 13 Position, 1.5 mm [.059 in] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder,

Power & Signal

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Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Type: PCB Mount Header

PCB Mount Orientation: Horizontal Connector System: Wire-to-Board

Number of Positions: 13

Number of Rows: 1

Features

Product Type Features

PCB Connector Type	PCB Mount Header
Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly
Configuration Features	
Number of Columns	13
Number of Loaded Positions	13
PCB Mount Orientation	Horizontal
Number of Positions	13
Number of Rows	1
Electrical Characteristics	

50 VDC

Operating Voltage



Body Features

Body Features	
Primary Product Color	Black
Contact Features	
Contact Mating Area Plating Material Finish	Matte
Contact Mating Area Plating Material Thickness	1 – 2.5 μm[39.37 – 98.42 μin]
Mating Square Post Dimension	.5 mm[.02 in]
Contact Mating Area Plating Material	Tin (Sn)
Contact Type	Pin
Contact Current Rating (Max)	2 A
Termination Features	
Square Termination Post & Tail Dimension	.5 mm[.02 in]
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
Mating Retention	With
Mating Alignment Type	Polarization
PCB Mount Retention	With
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Mating Alignment	With
Housing Features	
Housing Material	Nylon(G.F)
Centerline (Pitch)	1.5 mm[.059 in]
Dimensions	
Connector Width	8.45 mm[.33 in]
Connector Height	4.9 mm[.19 in]
Connector Length	22 mm[.866 in]
Usage Conditions	
Operating Temperature Range	-30 - 105 °C[-22 - 221 °F]
Operation/Application	
Circuit Application	Power & Signal
Industry Standards	
UL Flammability Rating	UL 94V-0



Packaging Features

Packaging Quantity	650	
Packaging Method	Box	

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Customers Also Bought

PCB Mount Header, Horizontal, Wire-to-Board, 13 Position, 1.5 mm [.059 in] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder, Power & Signal





TE Part #3-292206-5 MINI CT SGL DIP H 15P BLACK



TE Part #3-292206-7 MINI CT SGL DIP H 17P BLACK



TE Part #2-292215-5 MINI CT SGL RELAY 5P BLACK



TE Part #1-292230-4

1.5 MINI CT SGL V SMT W/BOSS 1



TE Part #9-292129-0 SGL HDR ASSY BOX DIP H W/KINK

TE Part #1-2308397-9

1.5 MINI CT SGL V SMT W/BOSS 19

TE Part #1376161-1
BJ HEAD CONNECTOR 28POS
ASSEMB



TE Part #9-292131-0 SGL HDR ASSY BOX DIP V POLARIS

Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_3-292206-3_E1.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_3-292206-3_E1.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_3-292206-3_E1.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

Product Specifications

Application Specification

English

Agency Approvals

PCB Mount Header, Horizontal, Wire-to-Board, 13 Position, 1.5 mm [.059 in] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder, Power & Signal



UL

English